











Summary of Chip requests

21/3/2001

Text summary	Reference	Date	Requester	Purpose	Response summary	Detailed reference	Selected	Picked	Sent	Comments
28 chips for forward	SSG minutes 44	5-Mar-01	Wladek/ Lutz Feld?	Fwd hybrid/module	14 chips will be sent initially from old wafers; more later		9-Mar-01	9-Mar-01	13-Mar-01	Lutz Feld collected
Wafer 4, 5 or 10 chips for barrel	 MS Word 2001 Document	20-Feb-01	Mike Tyndel	Barrel module	8 chips taken from wafer 4		5-Mar-01	5-Mar-01	7-Mar-01	None left from wafer 10; Dave Charlton Collected
10 chips, second quality	 MS Word 2001 Document	5-Mar-01	Mike Tyndel	RAL testing	10 chips from old wafers		9-Mar-01	9-Mar-01	13-Mar-01	Mike T. collected
7 modules worth ~100 chips	 MS Word 2001 Document	6-Mar-01	Lutz Feld	Fwd module program	92 chips sent		19-Mar-01	20-Mar-01	21-Mar-01	These are fast corner chips; Edgetek confused W17 &19 (corrected)
168 'fixed' chips now, more later (unclear: see ref)	 MS Word 2001 Document	7-Mar-01	Nobu Unno	Barrel module programme	28 for japan, 28 uk immediately;		16-Mar-01			56 UK, 56 japan,28 nordic, 28 US: OF WHICH: 28 chips sent to Japan 21 March, 28 chips to be collected by J. Carter 22 March
14 chips from wafer 5 for the UK		7-Mar-01	Nobu Unno	Barrel module irradi.	Request changed: replace by next line					
14 chips from fast corner, wafer 19/20	 MS Word 2001 Document	15-Mar-01	Wladek	Barrel module irradi.	14 chips immediately to UK		16-Mar-01	16-Mar-01	16-Mar-01	Mike T. collected
14 ABCD3T-A chips for Freiburg	 MS Word 2001 Document	19-Mar-01	Lutz Feld	Possible fwd hybrid irradiation	14 chips to be sent immediately		20-Mar-01	21-Mar-01		